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1. Name of conveying party(ics):	Name: Uchiya Thermostat Co., Ltd.
Hideaki Takeda	Street Address: 2-176-1, Takasu, Misato-shi
Additional name(s) of conveying party(ies) attached?	Saitama 341-0037 Japan
[]Yes [X]No	Additional name(s) & address(cs) attached? []Yes [X]No
3. Nature of conveyance:	
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Execution Date: January 10, 2008	
4. Application number(s) or patent number(s):If this document is being filed together with a new application	m, the execution date of the application is:
A. Patent Application No.(s)	B. Patent No.(s)
Serial No. 11/990,881, filed February 22, 2008	
Additional numbers attached? []Yes [X]No	
	 Total number of applications and patents involved: 1
 Name and address of party to whom correspondence concerning document should be mailed; 	7. Total fee (37 CFR 3.41):\$ 40.00
Name: Robert B. Madden	[]Enclosed
Address:	[X]Authorized to be charged to deposit account 19-0743
Schwegman, Lundberg & Woessner, P.A. P.O. Box 2938 Minneapolis, MN 55402-0938	 Please charge any additional fees or credit any over payments to our Deposit Account No.: 19-0743
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9. Statement and signature.	
<u>-</u>	mation is true and correct and any attached copy is a true copy
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> PATENT REEL: 022468 FRAME: 0952

Total number of pages including cover sheet: 3

ASSIGNMENT

WHEREAS, I, <u>Hideaki TAKEDA</u>, residing at <u>c/o UCHIYA THERMOSTAT CO.</u>, <u>LTD., 2-176-1, Takasu, Misato-shi, Saitama 341-0037, Japan</u>, made certain new and useful inventions and improvements for which I executed an application for Letters Patent of the United States on <u>even date herewith</u>, which is entitled <u>TEMPERATURE SWITCH</u>;

AND WHEREAS, <u>UCHTYA THERMOSTAT CO.</u>, <u>LTD.</u>, a corporation organized and existing under and by virtue of the laws of Japan, and having an office and place of business at <u>2-176-1</u>, <u>Takasu</u>, <u>Misato-shi</u>, <u>Saitama 341-0037</u>, <u>Japan</u> (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations in-part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, I do hereby agree that I and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to me relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore, I covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me.

PATENT REEL: 022468 FRAME: 0953 IN TESTIMONY WHEREOF, I have hereunto set my hand this 10 day of January, 2008.

Hideaki Jakeda ___

Hideaki TAKEDA

WITNESS:

Name Shojiro MAEDA

January 10, 2008

Date

PATENT REEL: 022468 FRAME: 0954

RECORDED: 03/27/2009